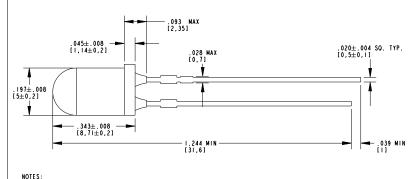
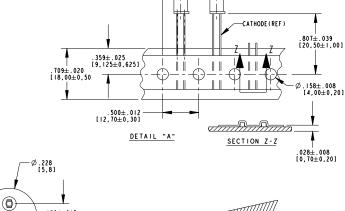


ABSOLUTE MAXIMUM RATINGS AT 25°C AMBIENT	VALUE	UNITS
DC FORWARD CURRENT	50	mA
PEAK FORWARD CURRENT	100	mA
AVERAGE FORWARD CURRENT	30	mA
REVERSE VOLTAGE (IR = 100 μA)	5	٧
DERATE LINEARLY FROM 55°C	0.67	mA/°C
OPERATING TEMPERATURE	-40 TO +100	°C
STORAGE TEMPERATURE	-40 TO +120	°C
WAVE SOLDERING TEMPERATURE, 3 SEC, 1/16" BELOW BODY	250	°C
COLORD DIDDING TEMPERATURE & CCC 1/10" RELOW RODY	260	°C



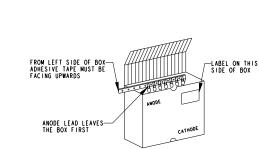


REV ECN NO

A

.250±051 [6,35±1,35]

.100±.015 [2,54±0,38]



REVISIONS

NEW RELEASE

DRN CKD APP DATE

KLJ

.500±.039 [12,70±1,00]

AMMO PACK PACKAGING

I. EPOXY COLOR: CLEAR NON-DIFFUSED.

- 2. DIE: TS AlinGaP, AMBER.
- LEADS: TIN (Sn), SILVER (Ag), COPPER (Cu) PLATING ON MILD STEEL.
- SOLDER ADHERANCE: BOTH LEADS PER MIL. STD. 202E, METHOD 208C, EXCEPT STEAM AGING.
- LEAD SPACING MEASURED NEAR EPOXY PACKAGE. 5.
- LEDS TO BE PACKAGED IN AMMO PACK AS SHOWN ON DRAWING (2000 PCS/BOX).
- INTENSITY BIN TOLERANCE IS ± 15 %.
- 8. COLOR BIN TOLERANCE IS $\pm 0.5 \ \text{nm}.$
- 9. DIALIGHT PART NUMBER: 521-8089F

RoHS Compliant 521-8089F

Part Numbers with the "F" suffix ending are RoHS Compliant.
Reel and bag packaging are marked with "RoHS Compliant" label or equivalent markings. Parts can be wave soldered, dip soldered or hand soldered using typical lead-free soldering process with max 260°C temp. for 5 sec.

